## XMC-P2000E-SDI-210 CHIP-DOWN DESIGN



## NVIDIA® QUADRO® PASCAL™ GP107, INCLUDES 2 SDI INPUT, 2 SDI OUTPUT

### **KEY FEATURES**

- NVIDIA GP107, 2.3 TFLOPS GPGPU Engine
- Chip-down rugged design, MIL-STD-810
- Up to two 3G-SDI inputs and two 3G-SDI outputs
- 4 GB GDDR5 memory with NVIDIA GPUDirect<sup>™</sup> DMA
- Operating power default: 25W; configurable hard cap from 25 - 60 Watts

### **ADDITIONAL FEATURES**

- Additional inputs: CVBS
- MCOTS option: STANAG 3350
- Additional outputs: DisplayPort ++
- DisplayPort 1.4 digital video outputs:
  upport for High Dynamic Range (HDR) video
  All at 100 lb at 510 at 500 bruth 100 bit color data
  - □ 4K at 120Hz or 5K at 60Hz with 10-bit color depth
- Pascal GPGPU parallel processing:
  - $\hfill\square$  768 CUDA  $^{\ensuremath{\texttt{B}}}$  cores
  - $\hfill\square$  CUDA Toolkit 9, CUDA Compute version 6.1
  - □ OpenCL<sup>™</sup> 1.2, DirectX<sup>®</sup> 12, OpenGL 4.5
  - □ Vulkan 1.0
- Memory width: 128-bit
- Maximum memory bandwidth: 96 GB/s
- NVENC/NVDEC accelerator for HEVC (H.265) and AVC (H.264) hardware encode/decode
- PCIe x4 Gen3
- Windows and Linux drivers

### **S**PECIFICATIONS

- High level of ruggedization:
  - $\hfill\square$  Rugged air-cooled or conduction-cooled
  - □ Operating temperature: -40° to +85°C
  - □ Vibration (sine wave): 10G peak, 5 2000Hz
  - □ Shock: 30G peak for air-cooled, 40G peak for conduction-cooled
- VITA 46.9 I/O compliant mapping for 3U and 6U VPX configurations
- Front I/O and Rear I/O configurations
- Available with XMC 1.0 or XMC 2.0 configurations

### **O**VERVIEW

WOLF's versatile Video Processing Unit (VPU) board includes both an advanced NVIDIA Quadro Pascal GPU and WOLF's Frame Grabber eXtreme (FGX). This board accepts multiple simultaneous inputs, including 3G-SDI and CVBS. The video data can be routed to the powerful Pascal GPU for processing or encoding, and then output in several formats, including 3G-SDI, DisplayPort, HDMI or DVI.

The WOLF Frame Grabber eXtreme (FGX) is the engine that provides the board with conversion of video data from one standard to another, with a wide array of video input and output options for both cutting-edge digital I/O and legacy analog I/O. The FGX has direct memory access (DMA) to the Quadro Pascal's GPU memory for GPU processing and complex analysis. By including both the versatile FGX and a high performance Quadro Pascal GPU on one board WOLF's I/O and processing solution avoids the SBC data rebroadcast traffic jams that commonly occur with a 2-board solution.



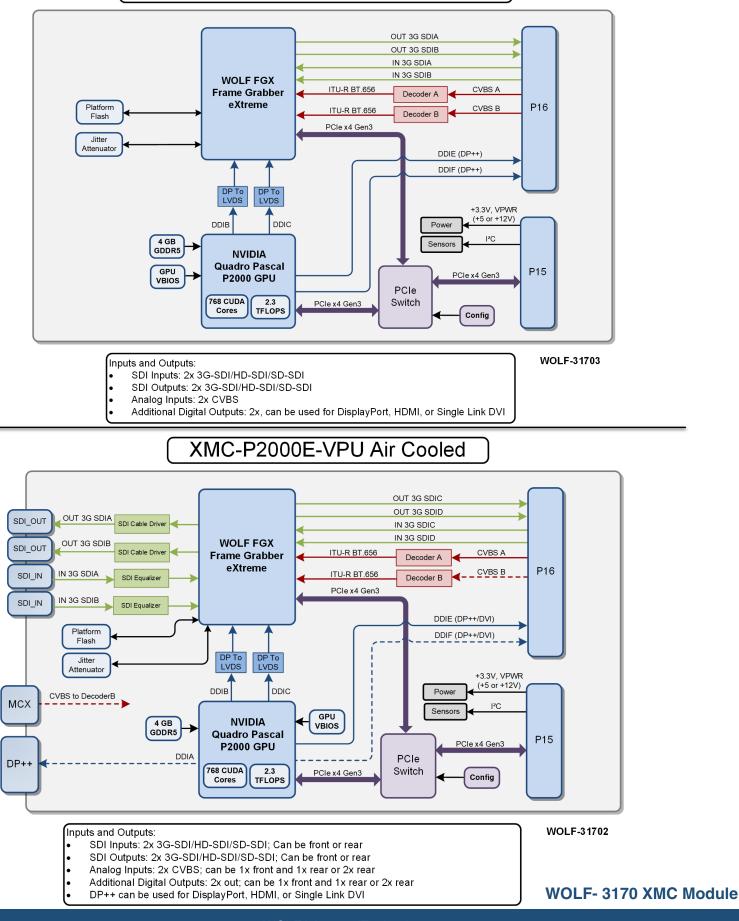
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NVIDIA<sup>®</sup> QUADRO<sup>®</sup>

# XMC-P2000E-SDI-2IO



#### XMC-P2000E-VPU Conduction Cooled



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### ORDERING CODES FOR XMC-P2000E-SDI-210

Part Number	Description
317021-F00**XMCv10	Air cooled, XMC 1.0, Front I0: 2xSDI In, 2x SDI Out, DP++ out, CVBS In, Rear IO: configurable, see block diagram
317022-F00**XMCv10	Air cooled, XMC 2.0, Front IO: 2xSDI In, 2x SDI Out, DP++ out, CVBS In, Rear IO: configurable, see block diagram
317031-F00**XMCv10	Conduction cooled, XMC 1.0, Rear IO: 2xSDI In, 2x SDI Out, 2x CVBS In, 2xDDI Out
317032-F00**XMCv10	Conduction cooled, XMC 2.0, Rear IO: 2xSDI In, 2x SDI Out, 2x CVBS In, 2xDDI Out

\*\* Contact Sales for full code definition. Code can specify: Conformal Coating, Modified Power Cap, Display Termination, other Part Numbers shown for Standard I/O configuration, contact Sales for additional I/O configuration options

### **MANUFACTURING AND QUALITY ASSURANCE**

WOLF designs modules to pass the following environmental standards:

- MIL-STD-810 (United States Military Standard for Environmental Engineering Considerations and Laboratory Tests)
- MIL-HDBK-217 (Reliability Prediction of Electronic Equipment)
- RTCA D0-160 (Environmental Conditions and Test Procedures for Airborne Equipment) on request

WOLF complies with the following quality management systems:

- ISO 9001:2015: Quality management systems (certified)
- SAE AS5553: Counterfeit Electronic Parts; Avoidance, Detection, Mitigation, and Disposition (compliant)
- SAE AS9100D: Quality Management System Requirements for Aviation, Space and Defense Organizations (preparing for certification in 2019)

Boards are manufactured to meet the following standards:

- IPC-A-610 CLASS 3 (Acceptability of Electronic Assemblies)
- IPC 6012 CLASS 3 (Qualification and Performance Specification for Rigid Printed Boards, Class 3 for High Reliability Electronic Products)
- IPC J-STD-001 (Requirements for Soldered Electrical and Electronic Assemblies)



#### WOLF- 3170 XMC Module